Performance Tuning Tips for Apache SPARK Machine Learning workloads

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Agenda

Spark Overview

Why OpenPower ?

OpenPower Design & Benefits

Spark on OpenPower

Performance Tuning Tips for Apache SPARK Machine Learning Workloads

Demo

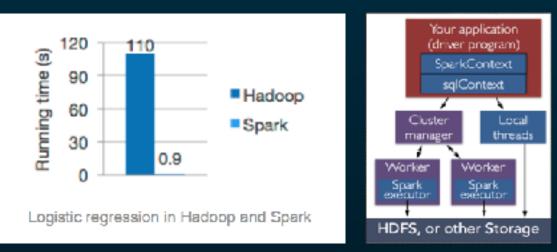
What is Apache Spark

- Unified Analytics Platform
 - Combine streaming, graph, machine learning and sql analytics on a single platform
 - Simplified, multi-language programming model
 - Interactive and Batch
- In-Memory Design
 - Pipelines multiple iterations on single copy of data in memory
 - Superior Performance
 - Natural Successor to MapReduce

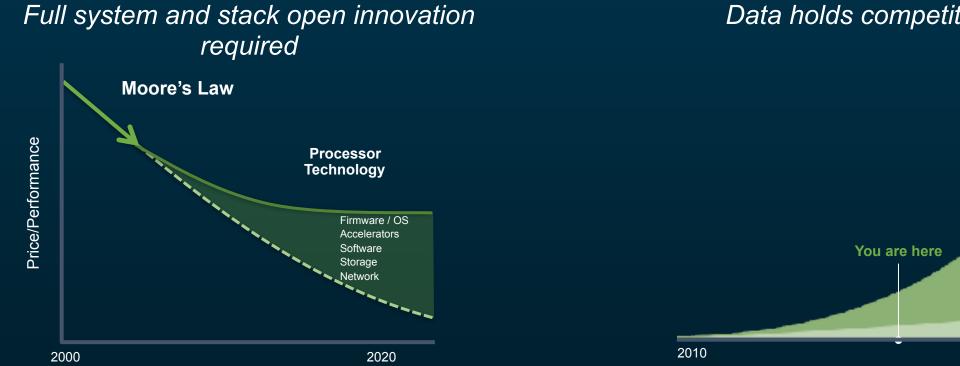


Fast and general engine for large-scale data processing





Today's challenges demand innovation



Data holds competitive value

Data Growth

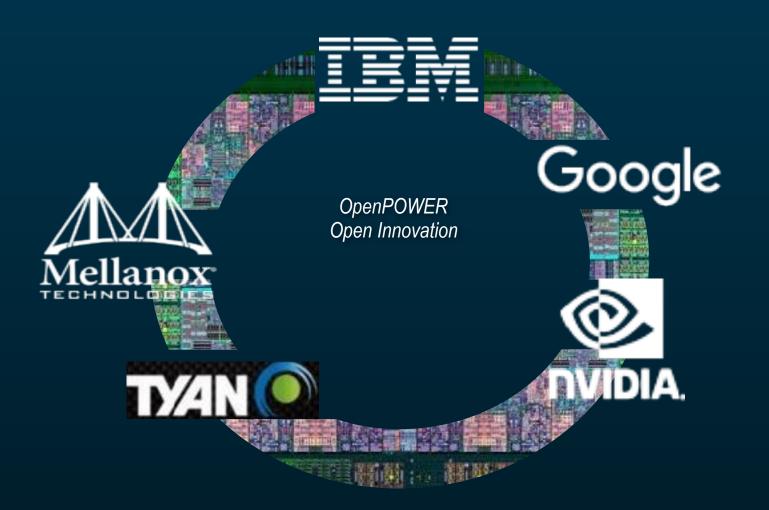
44 zettabytes

unstructured data

structured data

2020

Open Power Ecosystem



• Streaming and SQL benefit from High Thread Density and Concurrency

- Processing multiple packets of a stream and different stages of a message stream pipeline
- Processing multiple rows from a query

• Machine Learning benefits from Large Caches and Memory Bandwidth

- Iterative Algorithms on the same data
- Fewer core pipeline stalls and overall higher throughput

- Graph also benefits from Large Caches, Memory Bandwidth and Higher Thread Strength
 - Flexibility to go from 8 SMT threads per core to 4 or 2

• Manage Balance between thread performance and throughput

• Headroom

- Balanced resource utilization, more efficient scale-out
- Multi-tenant deployments

Machine workload deployment on Spark

Bigtop

• https://git-wip-us.apache.org/repos/asf?p=bigtop.git



POWER8 Processor - Design

Cores

- 12 cores / 8 threads per core
- TDP: 130W and 190W
- 64K data cache, 32K instruction cache

Accelerators

- Crypto & memory expansion
- Transactional Memory

Caches

- 512 KB SRAM L2 / core
- 96 MB eDRAM shared L3

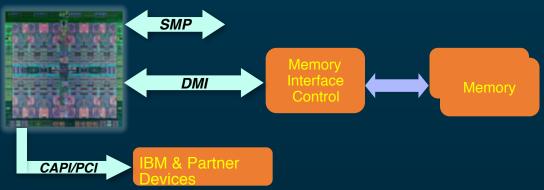
Memory Subsystem

- Memory buffers with 128MB Cache
- ~70ns latency to memory

Bus Interfaces

- Durable Memory attach Interface (DMI)
- Integrated PCIe Gen3
- SMP Interconnect for up to 4 sockets

22nm SOI, eDRAM, 15 ML 650mm2



Coherent Accelerator Processor Interface (CAPI)

- Virtual Addressing Accelerator can work with same memory addresses that the processors use
- Pointers de-referenced same as the host application
- Removes OS & device driver overhead

Hardware Managed Cache Coherence • Enables the accelerator to participate in

- "Locks" as a normal thread
- Lowers Latency over IO communication model

6 Hardware Partners developing with CAPI

Over 20 CAPI Solutions

All listed here http://ibm.biz/powercapi

Examples of Available CAPI Solutions

- IBM Data Engine for NoSQL
- DRC Graphfind analytics
- Erasure Code Accelération for Hadoop

Newly Announced OpenPOWER systems and solutions:

http://openpowerfoundation.org/wp-content/uploads/2016/04/HardwareRevealFlyerFinal.pdf

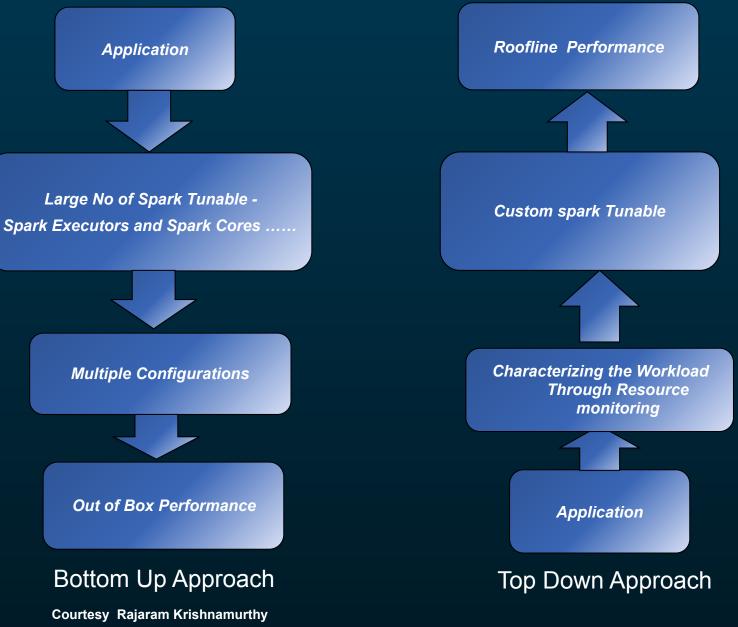
Performance Tuning Tips for SPARK Machine Learning Workloads

Methodology:

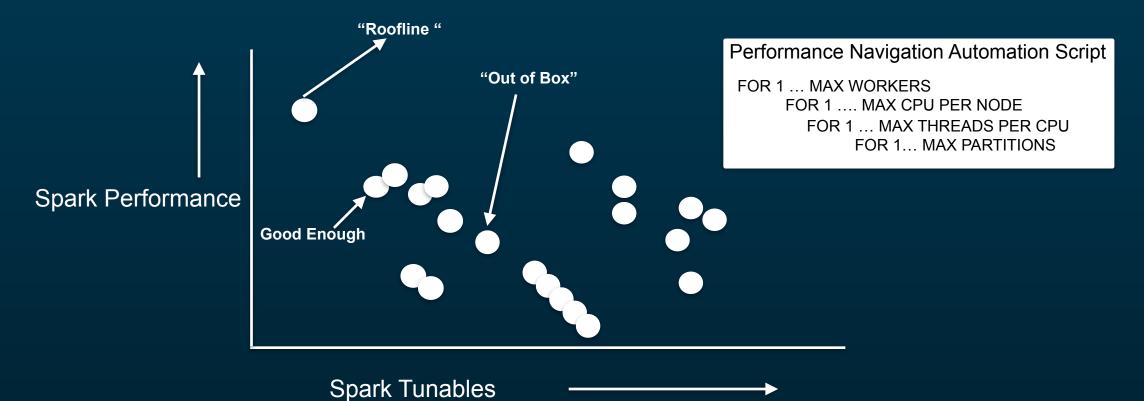
Alternating Least Squares Based Matrix Factorization application

Optimization Process:

Spark executor Instances Spark executor cores Spark executor memory Spark shuffle location and manager RDD persistence storage level



Roofline SPARK Performance Model



"Roofline" **Performance Navigation** uses system resource workload characterization and analysis to look for fundamental inefficiencies

WorkFlow

- Matrix Factorization from SPARKBENCH
 - https://github.com/SparkTC/spark-bench
- Training
- Validation
- Prediction

Data generation parameters	Value
Rows in data matrix	62000
Columns in data matrix	62000
Data set size	100 GB

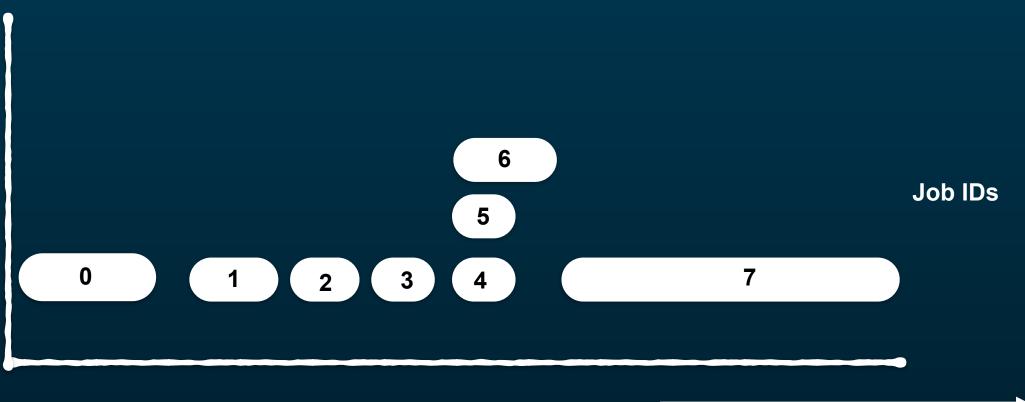
Parameters used for data generation in MF application

Spark parameter	Value for MF
Master node	1
Worker nodes	6
Executors per Node	1
Executor cores	80 / 40 /24
Executor Memory	480 GB
Shuffle Location	HDDs
Input Storage	HDFS

Spark environmen t details for application evaluation

Job	Function	Description / API called
7	Mean at MFApp.java	AbstractJavaRDDLike.map MatrixFactorizationModel.predict JavaDoubleRDD.mean
6	Aggregate at MFModel.scala	MatrixFactorizationModel.predict MatrixFactorizationModel.countApproxDistinctUserProduct
5	First at MFModel.scala	ml.recommendation.ALS.computeFactors
4	First at MFModel.scala	ml.recommendation.ALS.computeFactors
3	Count at ALS.scala	ALS.train and ALS.intialize
2	Count at ALS.scala	ALS.train
1	Count at ALS.scala	ALS.train
0	Count at ALS.scala	ALS.train

Description of jobs in MF application



ALS MF jobs execution over time

Data generation parameters	Value
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Columns in data matrix	62000
Data set size	100 GB

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	MFModel.scala	
3	Count at ALS.scala	ALS.train and ALS.intialize
2	Count at ALS.scala	ALS.train
1	Count at ALS.scala	ALS.train
0	Count at ALS.scala	ALS.train
*		
		6
		5
	0 1 2	3 4 7

Parameters used for data generation in MF application

Analyzing SPARK Configuration Sweep

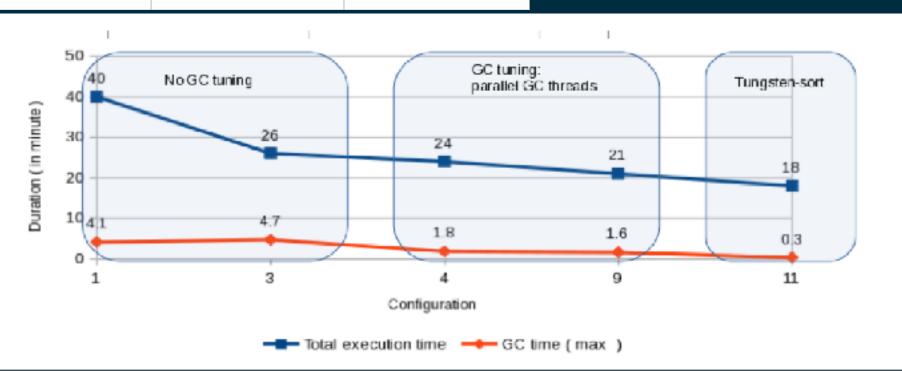
Various configurations tried in optimizing MF application on Spark

Configur ation	1	2	3	4	5	6	7	8	9	10	11
Spark executor cores	80	80	40	40	40	40	40	40	24	24	24
GC options	Default	Default	Default	ParallelGCth reads=40	ParallelGCth reads=40	ParallelGCth reads=40	ParallelGCth reads=40	ParallelGCth reads=40	ParallelGCth reads=24	ParallelGCth reads=24	Default
RDD compres sion	TRUE	FALSE	FALSE	FALSE	TRUE	TRUE	FALSE	FALSE	FALSE	FALSE	FALSE
Storage level	memory_a nd_disk	memory _only	memory _only	memory_onl y	memory_and _disk_ser	memory_onl y_ser	memory_onl y	memory_onl y	memory_and _disk_ser	memory_and _disk_ser	memory_ and_disk _ser
Partition numbers	1000	1000	1000	1000	1000	1000	800	1200	1000	1000	1000
Shuffle Manager	Sort based	Sort based	Sort based	Sort based	Sort based	Sort based	Sort based	Sort based	Sort based	Tungsten- sort	Tungsten- sort
Run- time (minutes)	40	34	26	24	20	25	26	27	21	19	18

GC and Memory Foot print

Configuration	Run time of last stage	GC time of last stage	
1	12 min	4.4 min	
4	4.4 min	1.8 min	
9	3.5 min	1.6 min	
11	47s	16s	

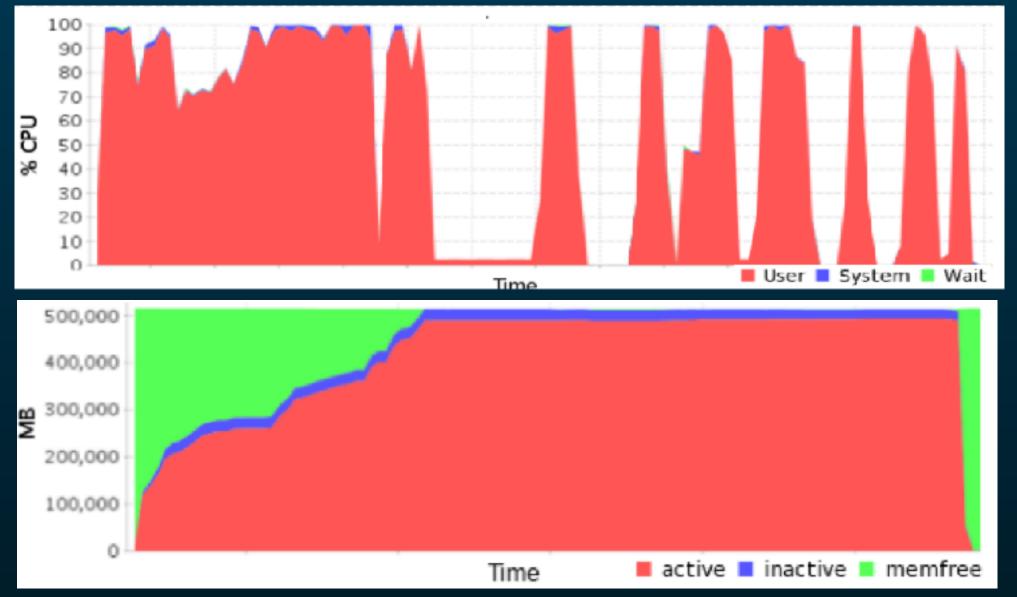
Run time and GC time of Stage 68 for different configurations



Last Stage Analysis

	Configuration	Duration	GC Time	Shuffle Details
#1	80 threads, Default GC, Memory+Disk	8.1 mins	1.2 mins	111 MB (Shuffle read), 1894MB (Shuffle Spill memory), 142 MB (Shuffle Spill Disk)
#5	40 threads, 40 GC, M+D Serialized	1.6 mins	17 secs	111 MB (Shuffle read)
#11	24 threads, M+D Serialized, Tungsten	38 secs	11 secs	111 MB (Shuffle read)

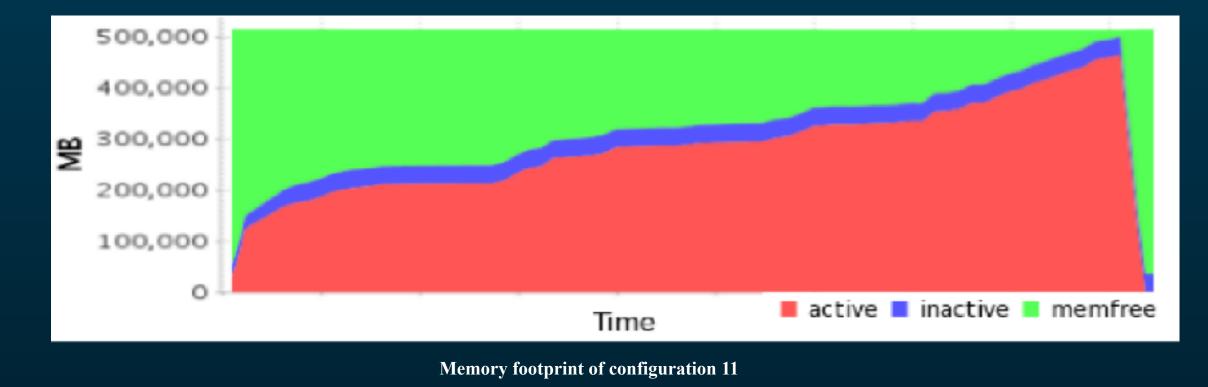
Characterizing Configuration #1



CPU utilization on a worker node (configuration 1)

> Memory utilization on a worker node (configuration 1)

Characterizing Configuration #1 and Configuration #11



Summary - How to Optimize Closer to Roofline Performance Faster?

- Classify workload into CPU, memory, IO or mixed (CPU, memory, IO) intensive
- Characterize "out-of-the-box" workload to understand CPU, Memory, IO and Network performance characteristics
- Floorplan cluster resources
- Tune "out-of-the-box" workload to navigate "Roofline" performance space in the above named dimensions
- If workload is memory/IO/Network bound then tune SPARK to increase operational intensity operations/byte as much as possible to make it CPU bound
- Divide search space into regions and perform exhaustive search

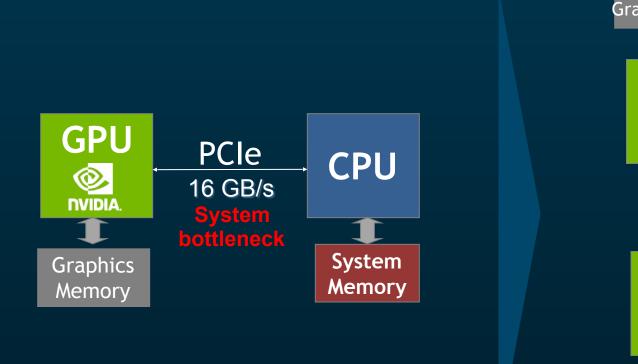
Performance Wall

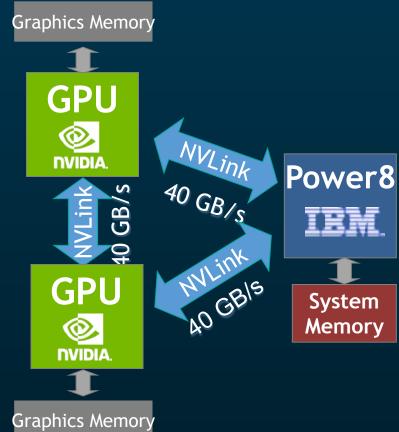


Accelerator Technology

Mellanox Interconnec	Connect-IB FDR Infiniband PCIe Gen3	ConnectX-4 EDR Infiniband CAPI over PCIe Gen3	ConnectX-5 Next-Gen Infiniband Enhanced CAPI over PCIe Gen4
NVIDIA S NVIDIA.	Kepler PCIe Gen3	Pascal NVLink	Volta Enhanced NVLink
IBM CPUs	POWER8 OpenPower CAPI Interface	POWER8 with NVLink	POWER9 Enhanced CAPI & NVLink
	2015	2016	2017

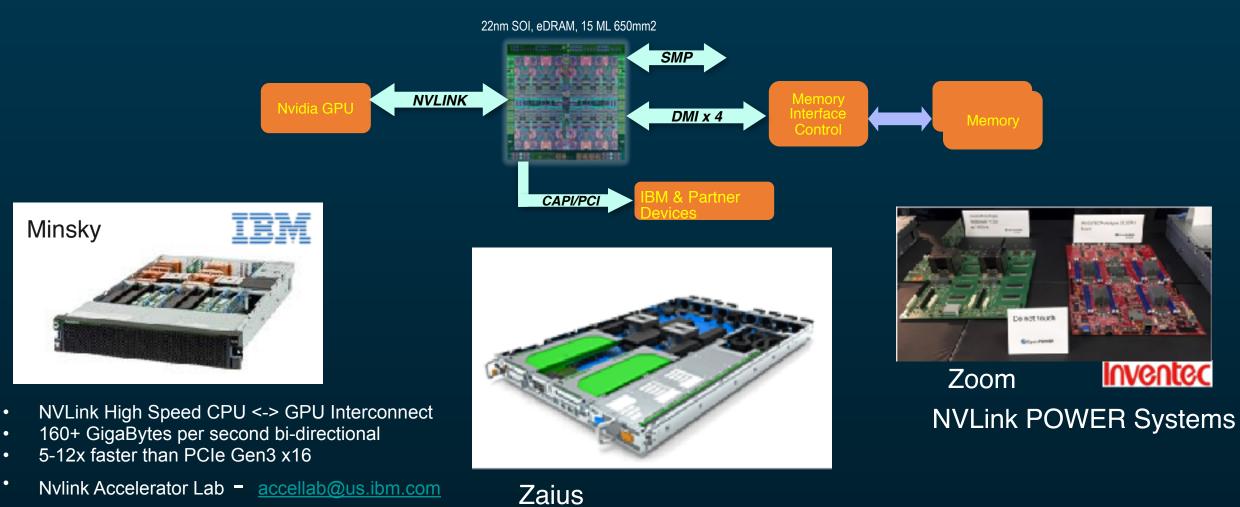
OpenPOWER Technology: 2.5x Faster CPU-GPU Connection via NVLink





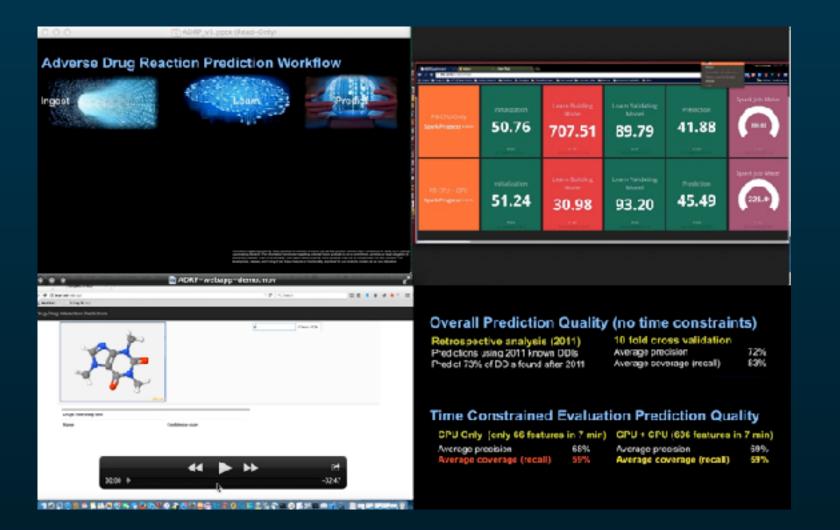
GPUs Bottlenecked by PCIe Bandwidth From CPU-System Memory NVLink Enables Fast Unified Memory Access between CPU & GPU Memories

POWER8 with NVLink



Google and Rackspace P9 server

Demo



GPU performance Demo

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